

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4846814

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TSUNG-YI HUANG	02/21/2018
CHING-YAO YANG	02/21/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	RICHTEK TECHNOLOGY CORPORATION
<b>Street Address:</b>	14F., NO.8, TAIYUAN 1ST ST.
<b>City:</b>	ZHUBEI CITY, HSINCHU
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15909277
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(248)540-4035
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	248-540-4040
<b>Email:</b>	tungassoc@aol.com
<b>Correspondent Name:</b>	TUNG & ASSOCIATES / RANDY W. TUNG, ESQ.
<b>Address Line 1:</b>	3349 SOUTH SHORE CIRCLE
<b>Address Line 4:</b>	WEST BLOOMFIELD, MICHIGAN 48323
<b>ATTORNEY DOCKET NUMBER:</b>	92,000-551(RH-1400)
<b>NAME OF SUBMITTER:</b>	RANDY W TUNG
<b>SIGNATURE:</b>	/Randy W Tung/
<b>DATE SIGNED:</b>	03/01/2018
<b>Total Attachments: 1</b>	
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92000-551

RH-1400 V106-010

**ASSIGNMENT**

WHEREAS, I/we, Tsung-Yi Huang, Ching-Yao Yang have invented certain improvements in:

**“HIGH VOLTAGE METAL OXIDE SEMICONDUCTOR DEVICE AND  
MANUFACTURING METHOD THEREOF”**

for which I am/we are about to make application for Letters Patent of the United States; and

WHEREAS, Richtek Technology Corporation, a company having a business address residing in R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, Tsung-Yi Huang, Ching-Yao Yang by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the following execution date, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

I/we further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I/we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

Tsung-Yi Huang  
(Signature by first inventor/assignor)

2018/02/21  
(Date)

Ching-Yao Yang  
(Signature by second inventor/assignor)

2018/2/21  
(Date)

**TUNG & ASSOCIATES**  
**3349 South Shore Circle**  
**West Bloomfield, MI 48323**